

Date Mailed: September 29, 2003

FORM 1449*

INFORMATION DISCLOSURE STATEMENT

IN AN APPLICATION

(Use several sheets if necessary)

Docket Number:
HSJ920030097US1

Application Number:
unassigned

Applicant: ALBRECHT et al.

Filing Date: 0929/2003

Group Art Unit: unassigned

U.S. PATENT DOCUMENTS

| EXAMINER INITIAL | DOCUMENT NO. | DATE | NAME | CLASS | SUBCLASS | FILING DATE IF APPROPRIATE |
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EXAMINER

A. Heinz

DATE CONSIDERED

4/3/05

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form for next communication to the Applicant.

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